

# HD74LV2GT74A

Single D-type Flip Flops with Preset and Clear

## HITACHI

ADE-205-681 (Z)

Rev.0  
Mar 2002

### Description

The HD74LV2GT74A has independent data, preset, clear, and clock inputs Q and  $\bar{Q}$  outputs in a 8 pin package. The input data is transferred to the output at the rising edge of clock pulse CLK. Low voltage and high speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

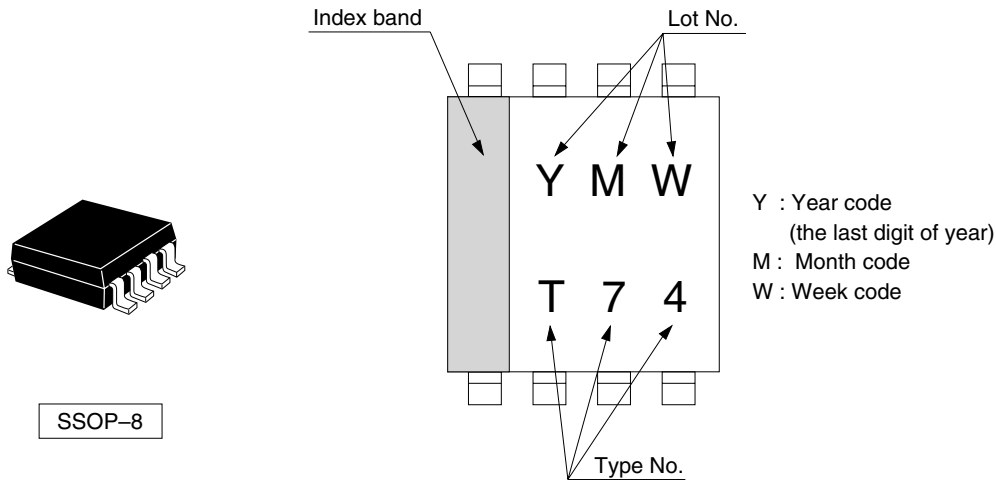
### Features

- The basic gate function is lined up as hitachi uni logic series.
- Supplied on emboss taping for high speed automatic mounting.
- TTL compatible input level.  
Supply voltage range : 4.5 to 5.5 V  
Operating temperature range : -40 to +85°C
- All inputs  $V_{IH}$  (Max.) = 5.5 V (@  $V_{CC}$  = 0 V to 5.5 V)  
All outputs  $V_O$  (Max.) = 5.5 V (@  $V_{CC}$  = 0 V)
- Output current  $\pm 12$  mA (@  $V_{CC}$  = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Package type

Package type	Package code	Package suffix	Taping code
SSOP-8 pin	TTP-8DB	US	E (3,000 pcs / Reel)

Outline and Article Indication

• HD74LV2GT74A



Function Table

Inputs				Outputs	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H <sup>**1</sup>	H <sup>**1</sup>
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	↓	X	Q <sub>0</sub>	$\overline{\text{Q}}_0$

H : High level

L : Low level

X : Immaterial

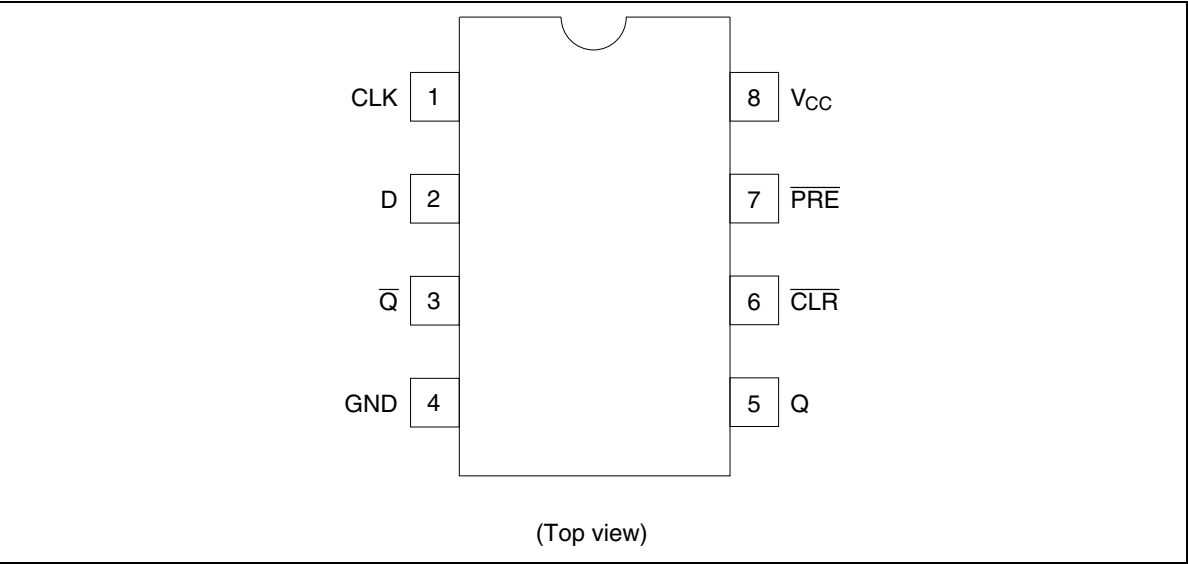
↑ : Low to high transition

↓ : High to low transition

Q<sub>0</sub> : The level of Q immediately before the input conditions shown in the above table are determined.

Note : 1. Q and  $\overline{\text{Q}}$  will remain high as long as preset and clear are low, but Q and  $\overline{\text{Q}}$  are unpredictable, if preset and clear go high simultaneously.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V	
Input voltage range <sup>*1</sup>	$V_I$	−0.5 to 7.0	V	
Output voltage range <sup>*1, 2</sup>	$V_O$	−0.5 to $V_{CC} + 0.5$ −0.5 to 7.0	V	Output : H or L $V_{CC}$ : OFF
Input clamp current	$I_{IK}$	−20	mA	$V_I < 0$
Output clamp current	$I_{OK}$	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	$I_O$	±25	mA	$V_O = 0$ to $V_{CC}$
Continuous current through $V_{CC}$ or GND	$I_{CC}$ or $I_{GND}$	±50	mA	
Maximum power dissipation at $T_a = 25^{\circ}\text{C}$ (in still air) <sup>*3</sup>	$P_T$	200	mW	
Storage temperature	$T_{stg}$	−65 to 150	°C	

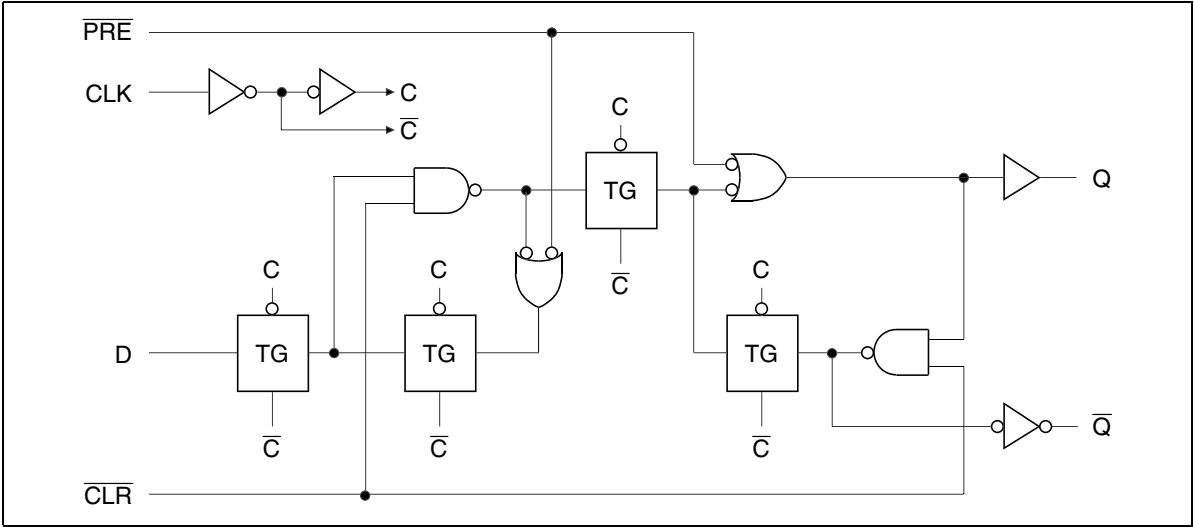
- Notes:     The absolute maximum ratings are values which must not individually be exceeded, and furthermore no two of which may be realized at the same time.
1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  2. This value is limited to 5.5 V maximum.
  3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit
Supply voltage	$V_{CC}$	4.5 to 5.5	V
Input voltage	$V_{IN}$	0 to 5.5	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	−40 to +85	°C
Input rise / fall time	$t_r, t_f$	0 to 20 ( $V_{CC} = 4.5$ to $5.5$ V)	ns

Note:   Unused or floating inputs must be held high or low.

Logic Diagram



Electrical Characteristic

• Ta = -40 to 85°C

Item	Symbol	V <sub>CC</sub> (V) *	Min	Typ	Max	Unit	Test condition
Input voltage	V <sub>IH</sub>	4.5 to 5.5	2.0	—	—	V	
	V <sub>IL</sub>	4.5 to 5.5	—	—	0.8		
Hysteresis voltage	V <sub>H</sub>	5.0	—	0.15	—	V	V <sub>T</sub> <sup>+</sup> - V <sub>T</sub> <sup>-</sup>
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>CC</sub> -0.1	—	—	V	I <sub>OH</sub> = -50 μA
		4.5	3.8	—	—		I <sub>OH</sub> = -12 mA
	V <sub>OL</sub>	Min to Max	—	—	0.1		I <sub>OL</sub> = 50 μA
		4.5	—	—	0.55		I <sub>OL</sub> = 12 mA
Input current	I <sub>IN</sub>	0 to 5.5	—	—	±1	μA	V <sub>IN</sub> = 5.5 V or GND
Quiescent supply current	I <sub>CC</sub>	5.5	—	—	10	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0
	ΔI <sub>CC</sub>	5.5	—	—	1.5	mA	One input V <sub>IN</sub> = 3.4 V, other input V <sub>CC</sub> or GND
Output leakage current	I <sub>OFF</sub>	0	—	—	5	μA	V <sub>O</sub> = 5.5 V
Input capacitance	C <sub>IN</sub>	5.0	—	2.5	—	pF	V <sub>IN</sub> = V <sub>CC</sub> or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

- $V_{CC} = 5.0 \pm 0.5 \text{ V}$

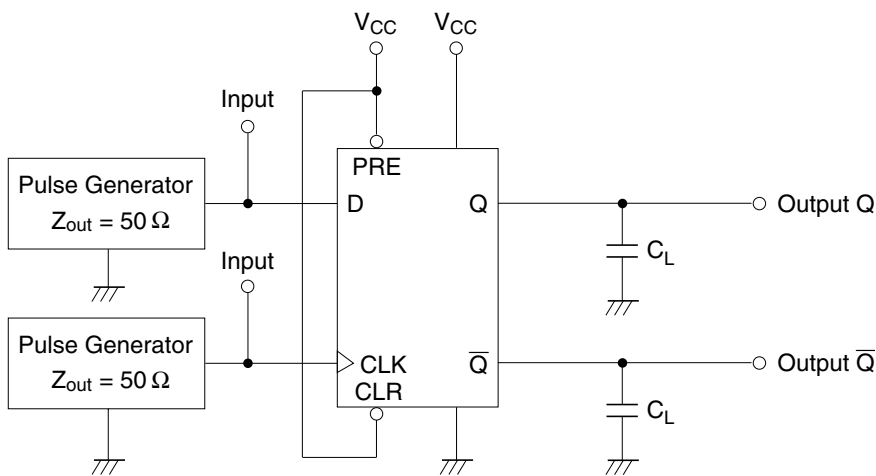
Item	Symbol	T <sub>a</sub> = 25°C			T <sub>a</sub> = −40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	f <sub>max</sub>	130	180	—	110	—	MHz	C <sub>L</sub> = 15 pF		
		90	140	—	75	—		C <sub>L</sub> = 50 pF		
Propagation delay time	t <sub>PLH</sub> t <sub>PHL</sub>	—	5.0	7.7	1.0	9.0	ns	C <sub>L</sub> = 15 pF	PRE/CLR	Q or Q̄
		—	5.6	7.3	1.0	8.5			CLK	
		—	6.6	9.7	1.0	11.0	ns	C <sub>L</sub> = 50 pF	PRE/CLR	Q or Q̄
		—	7.2	9.3	1.0	10.5			CLK	
Setup time	t <sub>su</sub>	5.0	—	—	5.0	—	ns		D	
		3.0	—	—	3.0	—			PRE or CLR inactive	
Hold time	t <sub>h</sub>	0.5	—	—	0.5	—	ns			
Pulse width	t <sub>w</sub>	5.0	—	—	5.0	—	ns		PRE or CLR	“L”
		5.0	—	—	5.0	—			CLK	“H” or “L”

Operating Characteristics

- $C_L = 50 \text{ pF}$

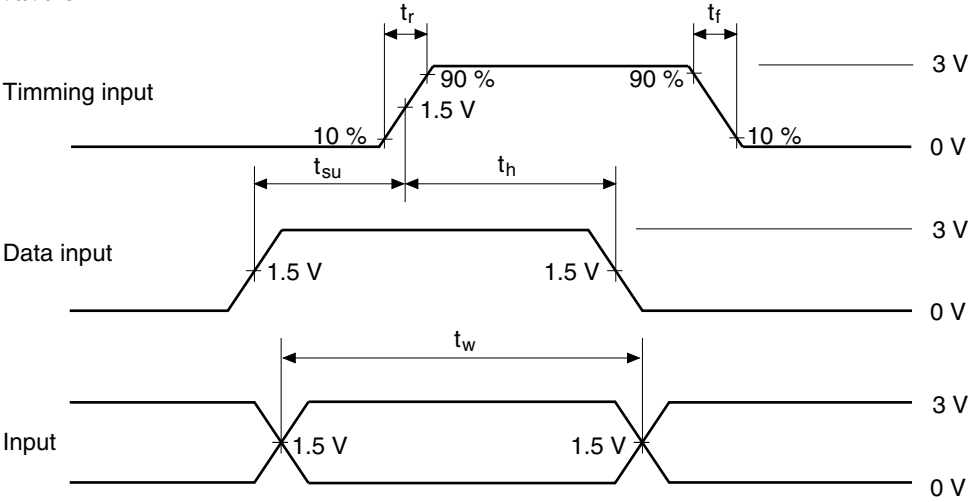
Item	Symbol	V <sub>CC</sub> (V)	T <sub>a</sub> = 25°C			Unit	Test Conditions
			Min	Typ	Max		
Power dissipation capacitance	C <sub>PD</sub>	5.0	—	14.0	—	pF	f = 10 MHz

Test Circuit

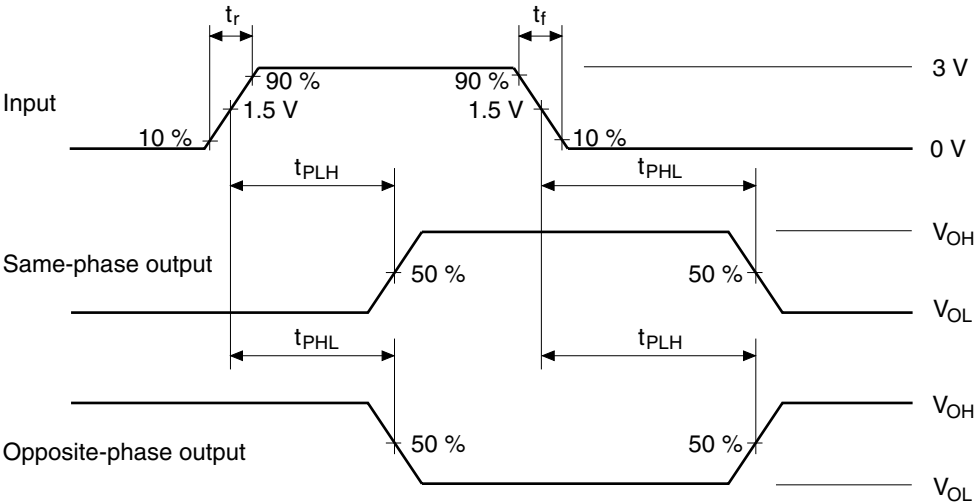


Notes: 1.  $C_L$  includes probe and jig capacitance.

• Waveform – 1



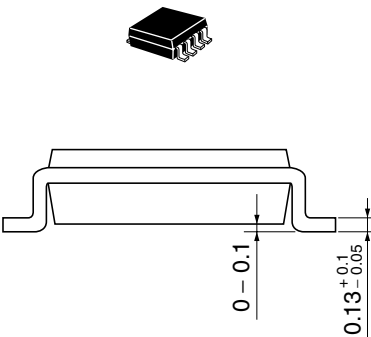
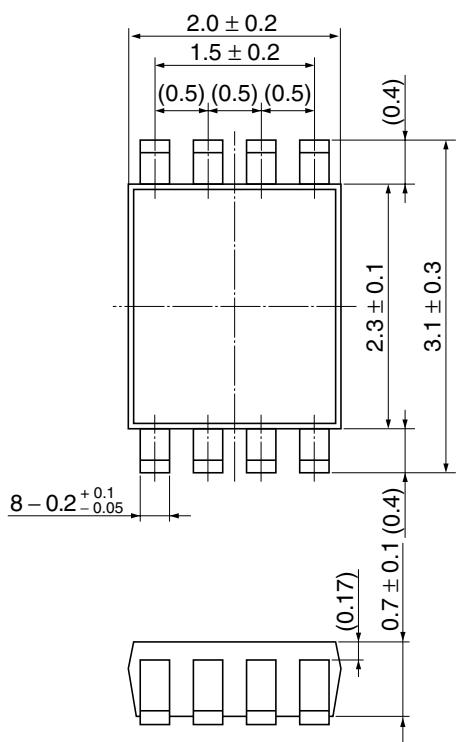
• Waveform – 2



Notes: 1. Input waveform :  $PRR \leq 1 \text{ MHz}$ ,  $Z_o = 50 \Omega$ ,  $t_r \leq 3 \text{ ns}$ ,  $t_f \leq 3 \text{ ns}$ .  
2. The output are measured one at a time with one transition per measurement.

Package Dimensions

As of July, 2001  
Unit: mm



Hitachi Code	TTP-8DB
JEDEC	—
JEITA	—
Mass (reference value)	0.010 g

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**Hitachi, Ltd.**  
Semiconductor & Integrated Circuits  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan  
Tel: (03) 3270-2111 Fax: (03) 3270-5109

URL <http://www.hitachisemiconductor.com/>

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive San Jose, CA 95134 Tel: <1> (408) 433-1990 Fax: <1> (408) 433-0223	Hitachi Europe Ltd. Electronic Components Group Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585200	Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00 Singapore 049318 Tel: <65>-538-6533/538-8577 Fax: <65>-538-6933/538-3877 URL: <a href="http://semiconductor.hitachi.com.sg">http://semiconductor.hitachi.com.sg</a>	Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: <852>-(2)-735-9218 Fax: <852>-(2)-730-0281 URL: <a href="http://semiconductor.hitachi.com.hk">http://semiconductor.hitachi.com.hk</a>
	Hitachi Europe GmbH Electronic Components Group Dornacher StraÙe 3 D-85622 Feldkirchen Postfach 201, D-85619 Feldkirchen Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00	Hitachi Asia Ltd. (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road Hung-Kuo Building Taipei (105), Taiwan Tel: <886>-(2)-2718-3666 Fax: <886>-(2)-2718-8180 Telex: 23222 HAS-TP URL: <a href="http://www.hitachi.com.tw">http://www.hitachi.com.tw</a>	

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